



NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE40H12K uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- V_{DS} =40V,I_D =120A
 R_{DS(ON)} <4.0mΩ @ V_{GS}=10V
 - $R_{DS(ON)}$ <7m Ω @ V_{GS}=4.5V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

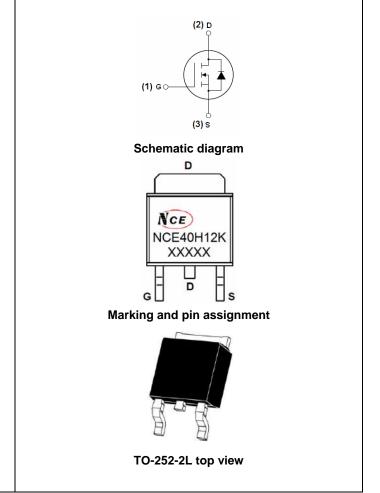
100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE40H12K	NCE40H12K	TO-252-2L	-	-	-

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	40	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι _D	120	А
Drain Current-Continuous(T _C =100°C)	I _D (100℃)	85	A
Pulsed Drain Current	I _{DM}	330	A
Maximum Power Dissipation	PD	120	W
Derating factor		0.8	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	1080	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C







Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	R _{θJC}	1.25	°C/W
Thermal Resistance, Junction-to-Ambient ^(Note 2)	$R_{ extsf{ heta}JA}$	55	°C/W

Electrical Characteristics (T_c=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·			•		
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	40	45	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	1.2	1.8	2.5	V
	R _{DS(ON)}	V _{GS} =10V, I _D =20A	-	3.6	4.0	mΩ
Drain-Source On-State Resistance		V _{GS} =4.5V, I _D =10A	-	5.8	7.0	
Forward Transconductance	g fs	V _{DS} =10V,I _D =20A	26	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}		-	5400	-	PF
Output Capacitance	Coss	V _{DS} =20V,V _{GS} =0V,	-	970	-	PF
Reverse Transfer Capacitance	Crss	F=1.0MHz	-	380	-	PF
Switching Characteristics (Note 4)						•
Turn-on Delay Time	t _{d(on)}		-	15	-	nS
Turn-on Rise Time	tr	V_{DD} =20V, I_D =2A, R_L =1 Ω	-	18	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _G =3Ω	-	52	-	nS
Turn-Off Fall Time	t _f		-	23	-	nS
Total Gate Charge	Qg	N/ 00N/1 00A	-	75		nC
Gate-Source Charge	Q _{gs}	$V_{DS}=20V, I_{D}=20A,$	-	10.5		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	17		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =40A	-		1.2	V
Diode Forward Current (Note 2)	I _S		-	-	120	А
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 40A	-	42	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	45	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LI				y LS+LD)

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

4. Guaranteed by design, not subject to production

5. E_{AS} condition : Tj=25 $^\circ \!\! \mathbb{C}$, V_{DD} =20V, V_G =10V, L=1mH, Rg=25\Omega ,

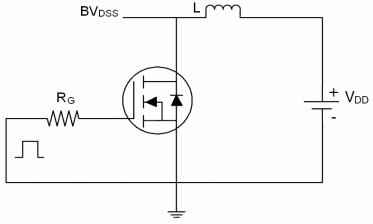
Surface Mounted on FR4 Board, t ≤ 10 sec. The value of R_{θJA} is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The Power dissipation PDSM is based on R_{θJA} and the maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design, and the maximum temperature of 175°C may be used if the PCB allows it.
 Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.



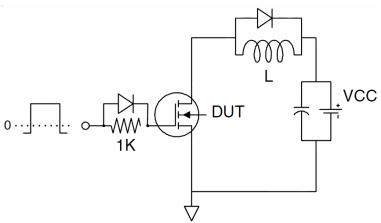
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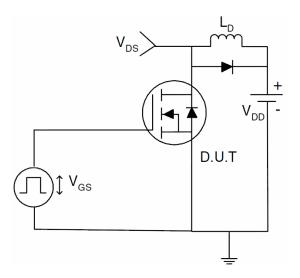
Test circuit 1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



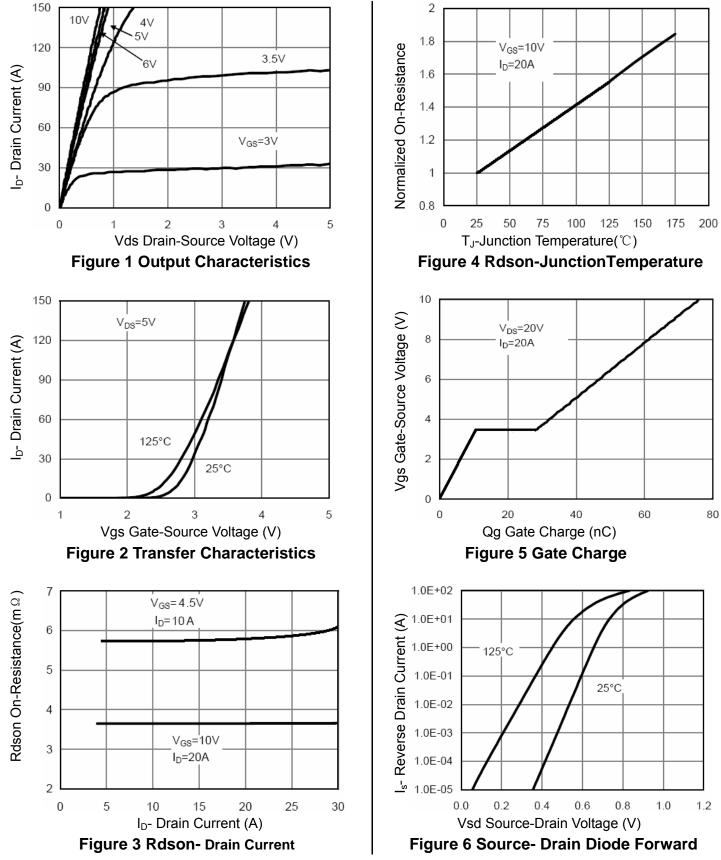
3) Switch Time Test Circuit







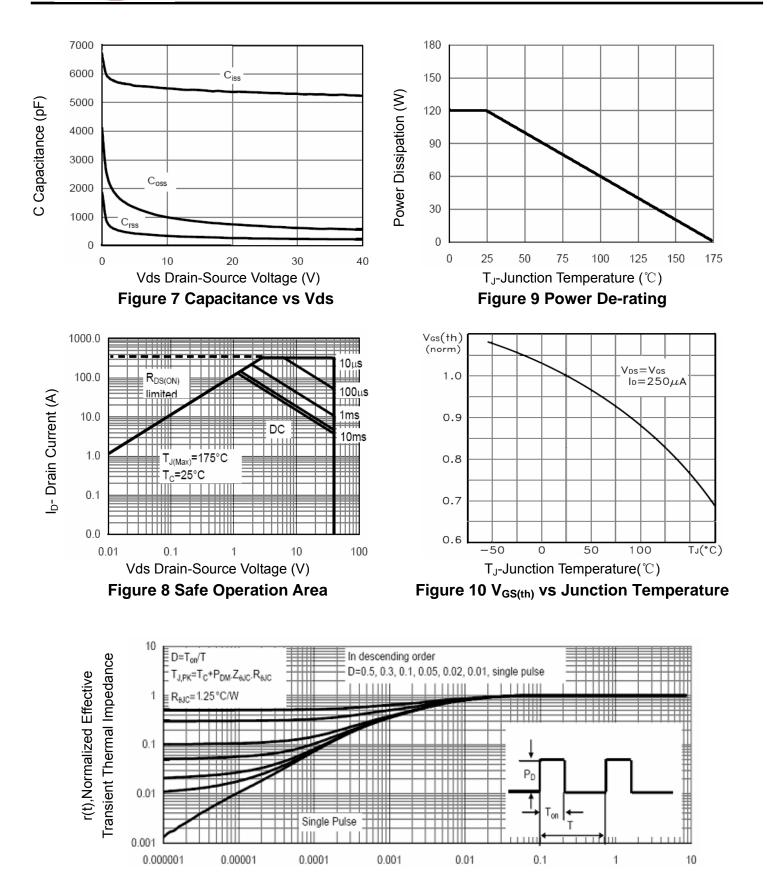






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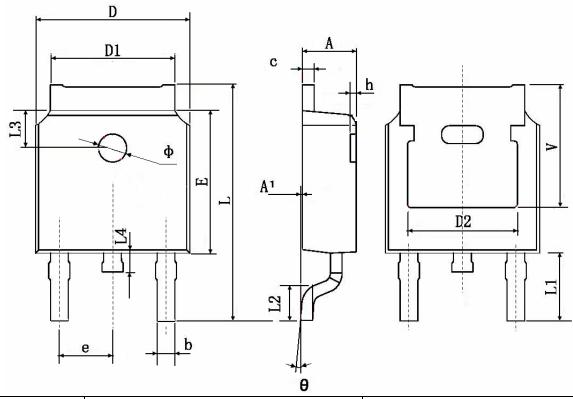




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TO-252 Package Information



Symbol	Dimensions	n Millimeters	Dimensions In Inches			
	Min.	Max.	Min.	Max.		
A	2.200	2.400	0.087	0.094		
A1	0.000	0.127	0.000	0.005		
b	0.660	0.860	0.026	0.034		
С	0.460	0.580	0.018	0.023		
D	6.500	6.700	0.256	0.264		
D1	5.100	5.460	0.201	0.215		
D2	4.830 TYP.		0.190 TYP.			
E	6.000	6.200	0.236	0.244		
е	2.186	2.386	0.086	0.094		
L	9.800	10.400	0.386	0.409		
L1	2.900 TYP.		0.114 TYP.			
L2	1.400	1.700	0.055	0.067		
L3	1.600	1.600 TYP.		0.063 TYP.		
L4	0.600	1.000	0.024	0.039		
Φ	1.100	1.300	0.043	0.051		
θ	0°	8°	0°	8°		
h	0.000	0.300	0.000	0.012		
V	5.350	TYP.	0.211	TYP.		





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